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Integrated 1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

Rev. 2 — 3 November 2011

Product data sheet

1. Product profile

1.1 General description

The devices are a family of RC low pass filters. They are designed to provide filtering of undesired RF signals on the I/O ports of portable communication or computing devices. The devices incorporate diodes to provide protection to downstream components from ElectroStatic Discharge (ESD) voltages up to ±25 kV.

The devices are fabricated using monolithic silicon technology in lead-free plastic packages.

Table 1. Product overview

Type number	Package	Number of channels	Package pitch (mm)	Package configuration
PEMI1QFN	SOT883	1	-	3-pin MicroPak (QFN compatible)
PEMI2QFN	SOT886	2	0.5	6-pin MicroPak (QFN compatible)
PEMI2STD	SOT665	1	-	5-pin microlead
PEMI4QFN	SOT1157-1	4	0.4	8-pin extremely thin leadless
PEMI6QFN	SOT1158-1	6	0.4	12-pin extremely thin leadless
PEMI8QFN	SOT1159-1	8	0.4	16-pin extremely thin leadless

1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- Integrated 1-, 2-, 4-, 6- and 8-channel π-type RC filter network
- ESD protection up to ±25 kV contact discharge according to IEC 61000-4-2, far exceeding level 4

1.3 Applications

General-purpose ElectroMagnetic Interference (EMI) and Radio-Frequency Interference (RFI) filtering and downstream ESD protection for:

- Cellular phone and Personal Communication Systems (PCS) mobile handsets
- Cordless telephones
- Wireless data (WAN/LAN) systems



1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

1.4 Quick reference data

Table 2.	Quick reference data			
Symbol	Parameter	Conditions	Тур	Unit
R _{s(ch)}	channel series resistance			
	PEMIxxxx/Cx		20	Ω
	PEMIxxxx/Hx		45	Ω
	PEMIxxxx/Lx		65	Ω
	PEMIxxxx/Rx		100	Ω
	PEMIxxxx/Wx		200	Ω
C _{ch}	channel capacitance	for the total channel; f = 100 kHz; V _{bias(DC)} = 0 V		
	PEMIxxxx/xE		15	pF
	PEMIxxxx/xG		19	pF
	PEMIxxxx/xK		23	pF
	PEMIxxxx/xM		28	pF
	PEMIxxxx/xP		32	pF
	PEMIxxxx/xR		36	pF
	PEMIxxxx/xT		40	pF

2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
PEMI1QF	N (SOT883)		
1 and 2	filter channel		D
3	ground (GND)	1 2 3 2 Transparent top view	$1 \xrightarrow{\text{Rs(ch)}} 2$ $1 \xrightarrow{\text{C}_{ch}} 2$ $1 \xrightarrow{\text{C}_{ch}} 2$ $3 \xrightarrow{\text{C}_{ch}} 3$ $018aaa042$
PEMI2QF	N (SOT886)		
1 and 6	filter channel 1		D
2 and 5	ground (GND)		1,3 + Rs(ch) 4,6
3 and 4	filter channel 2		$\begin{array}{c} \begin{array}{c} \\ \\ \end{array} \\ \\ \end{array} \\ \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \\ \end{array} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ $

Transparent top view

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

Table 3.	Pinning continued		
Pin	Description	Simplified outline	Graphic symbol
PEMI2STI	D (SOT665)		
1 and 5	filter channel 1	F 4	P- (-h)
2	ground (GND)		Rs(ch) 1,3 - + + - 4,5
3 and 4	filter channel 2		$\begin{array}{c} & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & & \\ & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & &$
PEMI4QF	N (SOT1157-1)		
1 and 8	filter channel 1		_
2 and 7	filter channel 2		R _{s(ch)} 1 to 4
3 and 6	filter channel 3		
4 and 5	filter channel 4	1 4	
ground pad	ground (GND)	Transparent top view	,,,, GND 018aaa071
PEMI6QF	N (SOT1158-1)		
1 and 12	filter channel 1		_
2 and 11	filter channel 2		Rs(ch) 1 to 6 7 to 12
3 and 10	filter channel 3		
4 and 9	filter channel 4	1 6	
5 and 8	filter channel 5	Transparent top view	r ↓, GND
6 and 7	filter channel 6		018aaa072
ground pad	ground (GND)		
PEMI8QF	N (SOT1159-1)		
1 and 16	filter channel 1	- 16 9	Re(-L)
2 and 15	filter channel 2		^R s(ch) 1 to 8 9 to 16
3 and 14	filter channel 3		$\pm \pm \frac{c_{ch}}{2} \pm \frac{c_{ch}}{2} \pm$
4 and 13	filter channel 4	1 8	
5 and 12	filter channel 5	Transparent top view	/ // GND
6 and 11	filter channel 6		018aaa073
7 and 10	filter channel 7		
8 and 9	filter channel 8		
ground pad	ground (GND)		

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

3. Ordering information

Table 4. Ordering information

Type number	Package	Package							
	Name	Description	Version						
PEMI1QFN	SC-101	leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.5 \text{ mm}$	SOT883						
PEMI2QFN	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886						
PEMI2STD	-	plastic surface-mounted package; 5 leads	SOT665						
PEMI4QFN	HXSON8	plastic thermal enhanced extremely thin small outline package; no leads; 8 terminals; body 1.2 \times 1.7 \times 0.5 mm	SOT1157-1						
PEMI6QFN	HXSON12	plastic thermal enhanced extremely thin small outline package; no leads; 12 terminals; body $1.2 \times 2.5 \times 0.5$ mm	SOT1158-1						
PEMI8QFN	HXSON16	plastic thermal enhanced extremely thin small outline package; no leads; 16 terminals; body 1.2 \times 3.3 \times 0.5 mm	SOT1159-1						

4. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+5.6	V
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2, level 4 all pins to ground			
		contact discharge	-	±15	kV
		air discharge	-	±15	kV
	PEMIxxxx/xM; PEMIxxxx/xP	contact discharge	-	±20	kV
		air discharge	-	±20	kV
	PEMIxxxx/xR; PEMIxxxx/xT	contact discharge	-	±25	kV
		air discharge	-	±25	kV
P _{ch}	channel power dissipation	continuous power; T _{amb} = 85 °C	-	60	mW
P _{tot}	total power dissipation	continuous power; T _{amb} = 85 °C	-	120	mW
T _{stg}	storage temperature		-55	+150	°C
T _{amb}	ambient temperature		-40	+85	°C

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

5. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{s(ch)}	channel series resistance					
	PEMIxxxx/Cx		18	20	22	Ω
	PEMIxxxx/Hx		40	45	50	Ω
	PEMIxxxx/Lx		58	65	72	Ω
	PEMIxxxx/Rx		90	100	110	Ω
	PEMIxxxx/Wx		180	200	220	Ω
C _{ch}	channel capacitance	for the total channel; f = 100 kHz				
	PEMIxxxx/xE	$V_{bias(DC)} = 0 V$	-	15	-	pF
		$V_{bias(DC)} = 2.5 V$	-	8.5	-	pF
	PEMIxxxx/xG	$V_{bias(DC)} = 0 V$	-	19	-	pF
		$V_{bias(DC)} = 2.5 V$	-	11	-	pF
	PEMIxxxx/xK	$V_{bias(DC)} = 0 V$	-	23	-	pF
		$V_{bias(DC)} = 2.5 V$	-	13.5	-	pF
	PEMIxxxx/xM	$V_{bias(DC)} = 0 V$	-	28	-	pF
		$V_{bias(DC)} = 2.5 V$	-	16	-	pF
	PEMIxxxx/xP	$V_{bias(DC)} = 0 V$	-	32	-	pF
		$V_{bias(DC)} = 2.5 V$	-	18.5	-	pF
	PEMIxxxx/xR	$V_{bias(DC)} = 0 V$	-	36	-	pF
		$V_{bias(DC)} = 2.5 V$	-	21	-	pF
	PEMIxxxx/xT	$V_{bias(DC)} = 0 V$	-	40	-	pF
		$V_{bias(DC)} = 2.5 V$	-	23	-	pF
V _{BR}	breakdown voltage	positive clamp; I _I = 1 mA	5.8	-	9	V
V _F	forward voltage	negative clamp; $I_F = 1 \text{ mA}$	-1.5	-	-0.4	V
I _{LR}	reverse leakage current	per channel; V _I = 3.5 V	-	-	0.1	μA

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
α _{il}	insertion loss	$C_{ch} = 15 \text{ pF}$				
	PEMIxxxx/CE	$R_{s(ch)} = 20 \ \Omega$				
		800 MHz < f < 3 GHz	7	-	-	dB
		f = 5 GHz	-	30	-	dB
	PEMIxxxx/HE	$R_{s(ch)} = 45 \ \Omega$				
		800 MHz < f < 3 GHz	9	-	-	dB
		f = 4 GHz	-	31	-	dB
	PEMIxxxx/LE	$R_{s(ch)} = 65 \ \Omega$				
		800 MHz < f < 3 GHz	11	-	-	dB
		f = 3.5 GHz	-	32	-	dB
	PEMIxxxx/RE	$R_{s(ch)} = 100 \ \Omega$				
		800 MHz < f < 3 GHz	13	-	-	dB
		f = 3 GHz	-	33	-	dB
	PEMIxxxx/WE	$R_{s(ch)} = 200 \ \Omega$				
		800 MHz < f < 3 GHz	18	-	-	dB
		f = 2.2 GHz	-	34	-	dB
x _{il}	insertion loss	C _{ch} = 19 pF				
	PEMIxxxx/CG	$R_{s(ch)} = 20 \ \Omega$				
		800 MHz < f < 3 GHz	9	-	-	dB
		f = 4 GHz	-	32	-	dB
	PEMIxxxx/HG	$R_{s(ch)} = 45 \ \Omega$				
		800 MHz < f < 3 GHz	11	-	-	dB
		f = 3.2 GHz	-	33	-	dB
	PEMIxxxx/LG	$R_{s(ch)} = 65 \ \Omega$				
		800 MHz < f < 3 GHz	13	-	-	dB
		f = 2.8 GHz	-	33.5	-	dB
	PEMIxxxx/RG	$R_{s(ch)} = 100 \ \Omega$				
		800 MHz < f < 3 GHz	15	-	-	dB
		f = 2.5 GHz	-	34	-	dB
	PEMIxxxx/WG	$R_{s(ch)} = 200 \ \Omega$				
		800 MHz < f < 3 GHz	21	-	-	dB
		f = 1.9 GHz	-	35.5	-	dB

Table 7. **Frequency characteristics**

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
α_{il}	insertion loss	$C_{ch} = 23 \text{ pF}$				
	PEMIxxxx/CK	$R_{s(ch)} = 20 \ \Omega$				
		800 MHz < f < 3 GHz	10	-	-	dB
		f = 3.6 GHz	-	33	-	dB
	PEMIxxxx/HK	$R_{s(ch)} = 45 \ \Omega$				
		800 MHz < f < 3 GHz	13	-	-	dB
		f = 2.8 GHz	-	34	-	dB
	PEMIxxxx/LK	$R_{s(ch)} = 65 \ \Omega$				
		800 MHz < f < 3 GHz	15	-	-	dB
		f = 2.5 GHz	-	35	-	dB
	PEMIxxxx/RK	R _{s(ch)} = 100 Ω				
		800 MHz < f < 3 GHz	18	-	-	dB
		f = 2.1 GHz	-	36	-	dB
	PEMIxxxx/WK	$R_{s(ch)} = 200 \ \Omega$				
		800 MHz < f < 3 GHz	24	-	-	dB
		f = 1.6 GHz	-	37	-	dB
α _{il}	insertion loss	$C_{ch} = 28 \text{ pF}$				
	PEMIxxxx/CM	$R_{s(ch)} = 20 \ \Omega$				
		800 MHz < f < 3 GHz	12	-	-	dB
		f = 3.2 GHz	-	34	-	dB
	PEMIxxxx/HM	$R_{s(ch)} = 45 \ \Omega$				
		800 MHz < f < 3 GHz	15	-	-	dB
		f = 2.5 GHz	-	35	-	dB
	PEMIxxxx/LM	$R_{s(ch)} = 65 \ \Omega$				
		800 MHz < f < 3 GHz	17	-	-	dB
		f = 2.1 GHz	-	36	-	dB
	PEMIxxxx/RM	R _{s(ch)} = 100 Ω				
		800 MHz < f < 3 GHz	21	-	-	dB
		f = 1.8 GHz	-	37	-	dB
	PEMIxxxx/WM	R _{s(ch)} = 200 Ω				
		800 MHz < f < 3 GHz	27	-	-	dB
		f = 1.4 GHz	-	38	-	dB

Table 7. Frequency characteristics ... continued $T_{amb} = 25$ °C: unless otherwise specified: $R_{anumo} = 50$ Q: $R_{L} = 50$ Q.

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
α _{il}	insertion loss	$C_{ch} = 32 \text{ pF}$				
	PEMIxxxx/CP	$R_{s(ch)} = 20 \ \Omega$				
		800 MHz < f < 3 GHz	13	-	-	dB
		f = 2.9 GHz	-	36	-	dB
	PEMIxxxx/HP	$R_{s(ch)} = 45 \ \Omega$				
		800 MHz < f < 3 GHz	17	-	-	dB
		f = 2.2 GHz	-	36	-	dB
	PEMIxxxx/LP	$R_{s(ch)} = 65 \ \Omega$				
		800 MHz < f < 3 GHz	19	-	-	dB
		f = 1.9 GHz	-	37	-	dB
	PEMIxxxx/RP	$R_{s(ch)} = 100 \ \Omega$				
		800 MHz < f < 3 GHz	23	-	-	dB
		f = 1.6 GHz	-	38	-	dB
	PEMIxxxx/WP	$R_{s(ch)} = 200 \ \Omega$				
		800 MHz < f < 3 GHz	30	-	-	dB
		f = 1.2 GHz	-	39	-	dB
α _{il}	insertion loss	C _{ch} = 36 pF				
	PEMIxxxx/CR	$R_{s(ch)} = 20 \ \Omega$				
		800 MHz < f < 3 GHz	14	-	-	dB
		f = 2.6 GHz	-	36	-	dB
	PEMIxxxx/HR	$R_{s(ch)} = 45 \ \Omega$				
		800 MHz < f < 3 GHz	18	-	-	dB
		f = 2.0 GHz	-	37	-	dB
	PEMIxxxx/LR	$R_{s(ch)} = 65 \ \Omega$				
		800 MHz < f < 3 GHz	21	-	-	dB
		f = 1.8 GHz	-	38	-	dB
	PEMIxxxx/RR	$R_{s(ch)} = 100 \ \Omega$				
		800 MHz < f < 3 GHz	25	-	-	dB
		f = 1.6 GHz	-	39	-	dB
	PEMIxxxx/WR	$R_{s(ch)} = 200 \ \Omega$				
		800 MHz < f < 3 GHz	32	-	-	dB
		f = 1.2 GHz	-	40	-	dB

Table 7. Frequency characteristics ... continued $T_{amb} = 25$ °C: unless otherwise specified: $R_{anumo} = 50$ Q: $R_{L} = 50$ Q.

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
α_{il}	insertion loss	$C_{ch} = 40 \text{ pF}$				
	PEMIxxxx/CT	$R_{s(ch)} = 20 \ \Omega$				
		800 MHz < f < 3 GHz	16	-	-	dB
		f = 2.5 GHz	-	36	-	dB
	PEMIxxxx/HT	$R_{s(ch)} = 45 \Omega$				
		800 MHz < f < 3 GHz	20	-	-	dB
		f = 1.9 GHz	-	38	-	dB
	PEMIxxxx/LT	$R_{s(ch)} = 65 \Omega$				
		800 MHz < f < 3 GHz	23	-	-	dB
		f = 1.6 GHz	-	39	-	dB
	PEMIxxxx/RT	$R_{s(ch)} = 100 \ \Omega$				
		800 MHz < f < 3 GHz	27	-	-	dB
		f = 1.4 GHz	-	40	-	dB
	PEMIxxxx/WT	R _{s(ch)} = 200 Ω				
		800 MHz < f < 3 GHz	32	-	-	dB
		f = 1.0 GHz	-	41	-	dB

Table 7. Frequency characteristics ... continued $T_{aret} = 25 \, ^{\circ}C$: unless otherwise specified: $R_{areteristic} = 50 \, O$: $R_{t} = 50 \, O$

6. Application information

6.1 Use cases

The selection of one of the filter devices has to be performed in dependence of the maximum clock frequency, the driver strength, the capacitive load of the sink and the maximum applicable rise and fall times.

6.2 LCD interfaces, medium-speed interfaces

For digital interfaces such as Liquid Crystal Display (LCD) interfaces running at clock speeds between 10 MHz and 25 MHz or more, the devices can be used in dependence of the sink load, the clock speed, the driver strength and the rise and fall time requirements. The minimum EMI filter requirements may be an important factor, too.

6.3 Keypad, low-speed interfaces

Especially for lower-speed interfaces such as keypads, low-speed serial interfaces and low-speed control signals, the devices offer a very robust ESD protection and strong suppression of unwanted frequencies (EMI filtering). Due to their small size the devices can easily be spread on a Printed-Circuit Board (PCB) in order to move the ESD and EMI protection close to the part of the design which shall be protected.

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

6.4 Insertion loss

The devices are designed as EMI/RFI filters for multichannel interfaces.

All measurements were performed in a typical 50 Ω NetWork Analyzer (NWA) setup as shown in <u>Figure 1</u>. The insertion loss was measured with a test Printed-Circuit Board (PCB) utilizing laser-drilled micro-via holes which connect the PCB ground plane to the devices ground pins.





1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



PEMIxQFN; PEMI2STD family

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



All important values of the RF behavior such as relative -3dB frequency, insertion loss at 800 MHz and above and also the DC attenuation in an NWA environment can be derived from the insertion loss response curves depicted in Figure 2 to <u>6</u>.

Note: insertion loss at low frequencies (1 MHz) is nearly independent from the channel capacitance values available within the PEMI family.

6.4.1 Relative –3dB frequency (π-filter structure)

Table 8.Relative –3dB frequency (MHz) per RC combination; typical values $T_{amb} = 25 \ ^{\circ}C$; unless otherwise specified.

PEMIxxxx/		хE	xG	хK	хM	хP	xR	хT
C _{ch} (pF)		15	19	23	28	32	36	40
PEMIxxxx/	R _{s(ch)}							
Cx	20	397 MHz	317 MHz	264 MHz	218 MHz	194 MHz	170 MHz	153 MHz
Hx	45	376 MHz	300 MHz	249 MHz	206 MHz	185 MHz	161 MHz	145 MHz
Lx	65	361 MHz	288 MHz	239 MHz	197 MHz	176 MHz	155 MHz	139 MHz
Rx	100	343 MHz	272 MHz	227 MHz	187 MHz	166 MHz	145 MHz	131 MHz
Wx	200	311 MHz	247 MHz	205 MHz	169 MHz	150 MHz	132 MHz	119 MHz

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

6.4.2 Insertion loss (dB) at 800 MHz (π -filter structure)

Table 9. Insertion loss (dB) at 800 MHz per RC combination; typical values

T _{amb} = 25 °C; ι	Inless	otherwise	specified.
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PEMIxxxx/		хE	xG	хK	хМ	хР	xR	хT
-			-					
C _{ch} (pF)		15	19	23	28	32	36	40
PEMIxxxx/	R _{s(ch)}							
Сх	20	-9 dB	–11 dB	–13 dB	–15 dB	-16 dB	–18 dB	–19 dB
Hx	45	-12 dB	-14 dB	–17 dB	–19 dB	–21 dB	–23 dB	–25 dB
Lx	65	-14 dB	–17 dB	–19 dB	–22 dB	–25 dB	–27 dB	–29 dB
Rx	100	–17 dB	–20 dB	–23 dB	–26 dB	–29 dB	–32 dB	–35 dB
Wx	200	–22 dB	–26 dB	–29 dB	–34 dB	-36 dB	–39 dB	–41 dB

6.4.3 Insertion loss (dB) at frequencies lower than 1 MHz (π -filter structure)

Table 10. Insertion loss (dB) at \leq 1 MHz per RC combination; typical values $T_{amb} = 25 \ ^{\circ}C$; unless otherwise specified.

PEMIxxxx/		хE	xG	хK	хМ	хP	xR	хТ
C _{ch} (pF)		15	19	23	28	32	36	40
PEMIxxxx/	R _{s(ch)}							
Cx	20	-1.6 dB	–1.6 dB	–1.6 dB				
Hx	45	–3.2 dB	-3.2 dB	–3.2 dB				
Lx	65	-4.3 dB	-4.3 dB	–4.3 dB	–4.3 dB	-4.3 dB	–4.3 dB	–4.3 dB
Rx	100	-6.0 dB						
Wx	200	–9.5 dB						

7. Marking

Table 11. Marking codes Type number Marking Type number Marking Type number Marking Type number Marking code code code code PEMI1QFN/CE CE PEMI2QFN/LP LP PEMI4QFN/CE CE PEMI6QFN/LP LP CG PEMI1QFN/CG CG PEMI2QFN/LR LR PEMI4QFN/CG PEMI6QFN/LR LR PEMI2QFN/LT PEMI4QFN/CK PEMI6QFN/LT PEMI1QFN/CK CK LT CK LT PEMI1QFN/CM CM PEMI2QFN/RE RE PEMI4QFN/CM CM PEMI6QFN/RE RE PEMI1QFN/CP CP PEMI4QFN/CP CP PEMI6QFN/RG PEMI2QFN/RG RG RG PEMI4QFN/CR PEMI1QFN/CR CR PEMI2QFN/RK RK CR PEMI6QFN/RK RK PEMI1QFN/CT СТ PEMI2QFN/RM RM PEMI4QFN/CT CT PEMI6QFN/RM RM PEMI1QFN/HE ΗE PEMI2QFN/RP RP PEMI4QFN/HE ΗE PEMI6QFN/RP RP PEMI1QFN/HG HG PEMI2QFN/RR RR PEMI4QFN/HG HG PEMI6QFN/RR RR PEMI1QFN/HK ΗK PEMI2QFN/RT RT PEMI4QFN/HK ΗK PEMI6QFN/RT RT PEMI1QFN/HM ΗM PEMI2QFN/WE WE PEMI4QFN/HM HM PEMI6QFN/WE WE PEMI1QFN/HP ΗP PEMI2QFN/WG WG PEMI4QFN/HP HP PEMI6QFN/WG WG PEMI1QFN/HR HR PEMI2QFN/WK WK PEMI4QFN/HR PEMI6QFN/WK WK HR PEMI1QFN/HT PEMI2QFN/WM WM PEMI4QFN/HT PEMI6QFN/WM ΗT ΗT WM

PEMIxQFN; PEMI2STD family

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

Table 11. Marki	ing codes	continued					
Type number	Marking code	Type number	Marking code	Type number	Marking code	Type number	Marking code
PEMI1QFN/LE	LE	PEMI2QFN/WP	WP	PEMI4QFN/LE	LE	PEMI6QFN/WP	WP
PEMI1QFN/LG	LG	PEMI2QFN/WR	WR	PEMI4QFN/LG	LG	PEMI6QFN/WR	WR
PEMI1QFN/LK	LK	PEMI2QFN/WT	WT	PEMI4QFN/LK	LK	PEMI6QFN/WT	WT
PEMI1QFN/LM	LM	PEMI2STD/CE	CE	PEMI4QFN/LM	LM	PEMI8QFN/CE	CE
PEMI1QFN/LP	LP	PEMI2STD/CG	CG	PEMI4QFN/LP	LP	PEMI8QFN/CG	CG
PEMI1QFN/LR	LR	PEMI2STD/CK	CK	PEMI4QFN/LR	LR	PEMI8QFN/CK	CK
PEMI1QFN/LT	LT	PEMI2STD/CM	CM	PEMI4QFN/LT	LT	PEMI8QFN/CM	СМ
PEMI1QFN/RE	RE	PEMI2STD/CP	CP	PEMI4QFN/RE	RE	PEMI8QFN/CP	CP
PEMI1QFN/RG	RG	PEMI2STD/CR	CR	PEMI4QFN/RG	RG	PEMI8QFN/CR	CR
PEMI1QFN/RK	RK	PEMI2STD/CT	СТ	PEMI4QFN/RK	RK	PEMI8QFN/CT	СТ
PEMI1QFN/RM	RM	PEMI2STD/HE	HE	PEMI4QFN/RM	RM	PEMI8QFN/HE	HE
PEMI1QFN/RP	RP	PEMI2STD/HG	HG	PEMI4QFN/RP	RP	PEMI8QFN/HG	HG
PEMI1QFN/RR	RR	PEMI2STD/HK	HK	PEMI4QFN/RR	RR	PEMI8QFN/HK	HK
PEMI1QFN/RT	RT	PEMI2STD/HM	HM	PEMI4QFN/RT	RT	PEMI8QFN/HM	HM
PEMI1QFN/WE	WE	PEMI2STD/HP	HP	PEMI4QFN/WE	WE	PEMI8QFN/HP	HP
PEMI1QFN/WG	WG	PEMI2STD/HR	HR	PEMI4QFN/WG	WG	PEMI8QFN/HR	HR
PEMI1QFN/WK	WK	PEMI2STD/HT	HT	PEMI4QFN/WK	WK	PEMI8QFN/HT	HT
PEMI1QFN/WM	WM	PEMI2STD/LE	LE	PEMI4QFN/WM	WM	PEMI8QFN/LE	LE
PEMI1QFN/WP	WP	PEMI2STD/LG	LG	PEMI4QFN/WP	WP	PEMI8QFN/LG	LG
PEMI1QFN/WR	WR	PEMI2STD/LK	LK	PEMI4QFN/WR	WR	PEMI8QFN/LK	LK
PEMI1QFN/WT	WT	PEMI2STD/LM	LM	PEMI4QFN/WT	WT	PEMI8QFN/LM	LM
PEMI2QFN/CE	CE	PEMI2STD/LP	LP	PEMI6QFN/CE	CE	PEMI8QFN/LP	LP
PEMI2QFN/CG	CG	PEMI2STD/LR	LR	PEMI6QFN/CG	CG	PEMI8QFN/LR	LR
PEMI2QFN/CK	СК	PEMI2STD/LT	LT	PEMI6QFN/CK	СК	PEMI8QFN/LT	LT
PEMI2QFN/CM	СМ	PEMI2STD/RE	RE	PEMI6QFN/CM	СМ	PEMI8QFN/RE	RE
PEMI2QFN/CP	СР	PEMI2STD/RG	RG	PEMI6QFN/CP	СР	PEMI8QFN/RG	RG
PEMI2QFN/CR	CR	PEMI2STD/RK	RK	PEMI6QFN/CR	CR	PEMI8QFN/RK	RK
PEMI2QFN/CT	СТ	PEMI2STD/RM	RM	PEMI6QFN/CT	СТ	PEMI8QFN/RM	RM
PEMI2QFN/HE	HE	PEMI2STD/RP	RP	PEMI6QFN/HE	HE	PEMI8QFN/RP	RP
PEMI2QFN/HG	HG	PEMI2STD/RR	RR	PEMI6QFN/HG	HG	PEMI8QFN/RR	RR
PEMI2QFN/HK	НК	PEMI2STD/RT	RT	PEMI6QFN/HK	НК	PEMI8QFN/RT	RT
PEMI2QFN/HM	HM	PEMI2STD/WE	WE	PEMI6QFN/HM	НМ	PEMI8QFN/WE	WE
PEMI2QFN/HP	HP	PEMI2STD/WG	WG	PEMI6QFN/HP	HP	PEMI8QFN/WG	WG
PEMI2QFN/HR	HR	PEMI2STD/WK	WK	PEMI6QFN/HR	HR	PEMI8QFN/WK	WK
PEMI2QFN/HT	HT	PEMI2STD/WM	WM	PEMI6QFN/HT	HT	PEMI8QFN/WM	WM
PEMI2QFN/LE	LE	PEMI2STD/WP	WP	PEMI6QFN/LE	LE	PEMI8QFN/WP	WP
PEMI2QFN/LG	LG	PEMI2STD/WR	WR	PEMI6QFN/LG	LG	PEMI8QFN/WR	WR
PEMI2QFN/LK	LK	PEMI2STD/WT	WT	PEMI6QFN/LK	LK	PEMI8QFN/WT	WT
PEMI2QFN/LM	LM	-	-	PEMI6QFN/LM	LM	-	-

Table 11. Marking codes ... continued

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

8. Package outline



Fig 7. Package outline PEMI1QFN (SOT883/SC-101)

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



Fig 8. Package outline PEMI2QFN (SOT886/XSON6)

PEMIxQFN; PEMI2STD family

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



Fig 9. Package outline PEMI2STD (SOT665)

PEMIxQFN; PEMI2STD family

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



HXSON8: plastic thermal enhanced extremely thin small outline package; no leads;

Fig 10. Package outline PEMI4QFN (SOT1157-1/HXSON8)

PEMIxQFN; PEMI2STD family

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



HXSON12: plastic thermal enhanced extremely thin small outline package; no leads; 12 terminals; body 1.2 x 2.5 x 0.5 mm

Fig 11. Package outline PEMI6QFN (SOT1158-1/HXSON12)

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



HXSON16: plastic thermal enhanced extremely thin small outline package; no leads;

Fig 12. Package outline PEMI8QFN (SOT1159-1/HXSON16)

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

9. Soldering



PEMIxQFN; PEMI2STD family

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



PEMIxQFN; PEMI2STD family

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection



1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

10. Revision history

Table 12. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PEMIXQFN_PEMI2STD_ FAM v.2	20111103	Product data sheet	-	PEMIXQFN_PEMI2STD_ FAM v.1
Modifications:	• <u>Table 3 "Pinning</u> simplified outlin	<u>p</u> : corrected pinning descr e of SOT886	iption for PEMI8QFN	(SOT1159-1); updated
	 Section 11 "Leg 	al information": updated		
PEMIXQFN_PEMI2STD_ FAM v.1	20110729	Product data sheet	-	-

1-, 2-, 4-, 6- and 8-channel passive filter network with ESD protection

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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